20 STERN AVE. SPRINGFIELD, NEW JERSEY 07081 U.S.A. M_IE122

MJF122, MJF127

Complementary Power Darlingtons

For Isolated Package Applications

Designed for general-purpose amplifiers and switching applications, where the mounting surface of the device is required to be electrically isolated from the heatsink or chassis.

Features

- Electrically Similar to the Popular TIP122 and TIP127
- 100 V_{CEO(sus)}
- 5.0 A Rated Collector Current
- No Isolating Washers Required
- Reduced System Cost
- High DC Current Gain 2000 (Min) @ I_C = 3 Adc
- UL Recognized, File #E69369, to 3500 V_{RMS} Isolation
- Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	ue Unit	
Collector-Emitter Voltage	V _{CEO}	100	Vdc	
Collector-Base Voltage	V _{CB}	100	Vdc	
Emitter-Base Voltage	V _{EB}	5	Vdc	
RMS Isolation Voltage (Note 1) (t = 0.3 sec, R.H. \leq 30%, T _A = 25°C) Per Figure 14	VISOL	4500	V _{RMŠ}	
Collector Current – Continuous Peak	lc	5 8	Adc	
Base Current	۱ _B	0.12	Adc	
Total Power Dissipation (Note 2) @ T _C = 25°C Derate above 25°C	PD	30 0.24	w w/∘c	
Total Power Dissipation @ T _A = 25°C Derate above 25°C	PD	2 0.016	W W/°C	
Operating and Storage Junction Temperat- ure Range	T _J , T _{stg}	−65 to +150	lc	

COMPLEMENTARY SILICON POWER DARLINGTONS 5.0 A, 100 V, 30 W

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THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	R _{0JA}	62.5	°C/W
Thermal Resistance, Junction-to-Case (Note 2)	R _{θJC}	4.1	°C/W
Lead Temperature for Soldering Purpose	ΤL	260	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



1. Proper strike and creepage distance must be provided.

 Measurement made with thermocouple contacting the bottom insulated mounting surface (in a location beneath the die), the device mounted on a heatsink with thermal grease and a mounting torque of ≥ 6 in. lbs.

Quality Semi-Conductors

MJF122, MJF127

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Sustaining Voltage (Note 3) $(I_{C} = 100 \text{ mAdc}, I_{B} = 0)$		V _{CEO(sus)}	100	-	Vdc
Collector Cutoff Current ($V_{CE} = 50 \text{ Vdc}, I_B = 0$)		ICEO	-	10	μAdc
Collector Cutoff Current $(V_{CB} = 100 \text{ Vdc}, I_E = 0)$		I _{CBO}	-	10	μAdc
Emitter Cutoff Current (V _{BE} = 5 Vdc, I _C = 0)		I _{EBO}	-	2	mAdc
ON CHARACTERISTICS (Note 3)					
DC Current Gain ($I_C = 0.5 \text{ Adc}$, $V_{CE} = 3 \text{ Vdc}$) ($I_C = 3 \text{ Adc}$, $V_{CE} = 3 \text{ Vdc}$)		h _{FE}	1000 2000	- -	-
Collector-Emitter Saturation Voltage ($I_C = 3 \text{ Adc}$, $I_B = 12 \text{ mAdc}$) ($I_C = 5 \text{ Adc}$, $I_B = 20 \text{ mAdc}$)		V _{CE(sat)}	-	2 3.5	Vdc
Base-Emitter On Voltage (I _C = 3 Adc, V _{CE} = 3 Vdc)		V _{BE(on)}	-	2.5	Vdc
DYNAMIC CHARACTERISTICS					
Small-Signal Current Gain (I _C = 3 Adc, V _{CE} = 4 Vdc, f = 1 MHz)		h _{fe}	4	-	-
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 0.1 MHz)	MJF127 MJF122	C _{ob}	-	300 200	pF

3. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.





Figure 2. Typical Switching Times